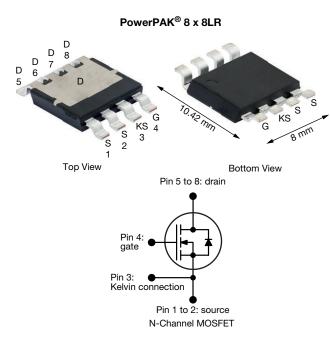
**Vishay Siliconix** 

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## **E Series Power MOSFET**



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.074			
Q <sub>g</sub> max. (nC)	63				
Q <sub>gs</sub> (nC)	19				
Q <sub>gd</sub> (nC)	10				
Configuration	Single				

#### FEATURES

- 4<sup>th</sup> generation E series technology
- Low figure of merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8LR
Lead (Pb)-free and halogen-free	SiHR080N60E-T1-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \text{ °C}$ , unless otherwise noted)							
PARAMETER		SYMBOL	LIMIT	UNIT			
Drain-source voltage		V <sub>DS</sub>	600	v			
Gate-source voltage			V <sub>GS</sub>	± 30	v		
Continuous drain current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	Ι <sub>D</sub>	51			
	VGS at TO V	$T_{\rm C} = 100 ^{\circ}{\rm C}$		32	А		
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	96			
Linear derating factor			4.0	W/°C			
Single pulse avalanche energy <sup>b</sup>		E <sub>AS</sub> 173		mJ			
Maximum power dissipation		PD	P <sub>D</sub> 500				
Operating junction and storage temperature ra	ange		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-source voltage slope		T <sub>J</sub> = 125 °C	100		V/ns		
Reverse diode dv/dt <sup>d</sup>			dv/dt	10	v/ns		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD} = 120 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ , L = 28.2 mH,  $R_q = 25 \Omega$ ,  $I_{AS} = 3.5 \text{ A}$ 

c. 1.6 mm from case

d.  $I_{SD} \leq I_D$ , di/dt = 100 A/µs, starting  $T_J$  = 25 °C

S24-0968-Rev. B, 23-Sep-2024

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COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	- 42			00.004			
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 0.25				°C/W		
	•	•			•			
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 $^{\circ}$ C,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 μΑ	600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.64	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	250 µA	3.0	-	5.0	V
		$V_{GS} = \pm 20 \text{ V}$			-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	, v	V <sub>GS</sub> = ± 30 V			-	± 1	μA
		V <sub>DS</sub> =	= 600 V, V <sub>G</sub>	<sub>S</sub> = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 480 V	′, V <sub>GS</sub> = 0 V	∕, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	١	<sub>D</sub> = 17 A	-	0.074	0.084	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub>	= 20 V, I <sub>D</sub> =	= 17 A	-	4.6	-	S
Dynamic					•	•		
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	2557	-	pF	
Output capacitance	C <sub>oss</sub>			-	105	-		
Reverse transfer capacitance	C <sub>rss</sub>			-	6	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS}$ = 0 V to 480 V, $V_{GS}$ = 0 V		-	79	-		
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	499	-		
Total gate charge	Qg				-	42	63	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	V <sub>GS</sub> = 10 V I <sub>D</sub> = 17 A, V <sub>DS</sub> = 480 V		-	19	-	nC
Gate-drain charge	Q <sub>gd</sub>				-	10	-	
Turn-on delay time	t <sub>d(on)</sub>		•		-	31	62	
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	$V_{DD}$ = 480 V, I <sub>D</sub> = 17 A, V <sub>GS</sub> = 10 V, R <sub>g</sub> = 9.1 Ω		-	96	144	ns
Turn-off delay time	t <sub>d(off)</sub>				-	37	74	
Fall time	t <sub>f</sub>			-	31	62		
Gate input resistance	R <sub>g</sub>	f = 1 MHz		0.3	0.7	1.4	Ω	
Drain-Source Body Diode Characterist								
Continuous source-drain diode current	IS	MOSFET sym showing the	MOSFET symbol showing the		-	-	51	
Pulsed diode forward current	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	96	A	
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 17 A, V <sub>GS</sub> = 0 V		-	-	1.2	V	
Reverse recovery time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = I_S = 17 \text{ A},$ di/dt = 80 A/µs, V <sub>R</sub> = 25 V		-	441	882	ns	
Reverse recovery charge	Q <sub>rr</sub>			-	5.2	10.4	μC	
Reverse recovery current	I <sub>RRM</sub>			-	21	_	A	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

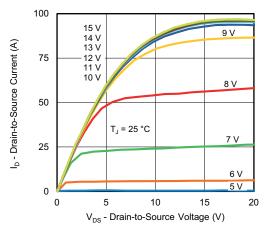


Fig. 1 - Typical Output Characteristics

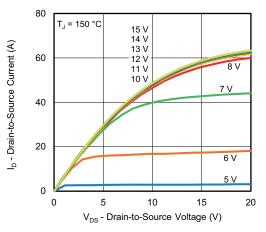


Fig. 2 - Typical Output Characteristics

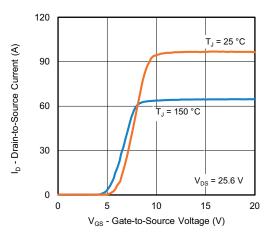


Fig. 3 - Typical Transfer Characteristics

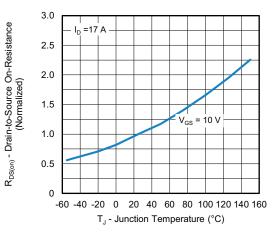


Fig. 4 - Normalized On-Resistance vs. Temperature

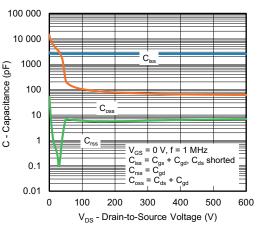


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

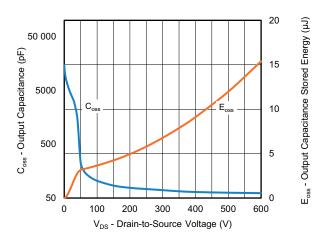


Fig. 6 -  $C_{\rm oss}$  and  $E_{\rm oss}$  vs.  $V_{\rm DS}$ 

**3** For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 92494

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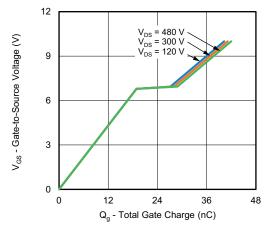


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

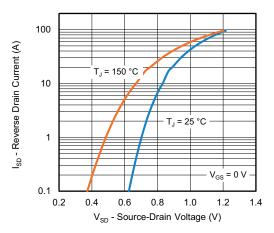


Fig. 8 - Typical Source-Drain Diode Forward Voltage

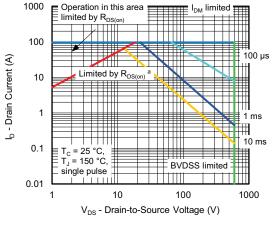
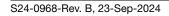


Fig. 9 - Maximum Safe Operating Area

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified



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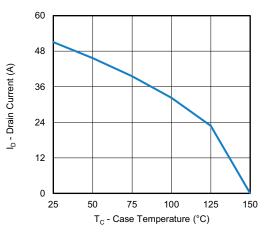


Fig. 10 - Maximum Drain Current vs. Case Temperature

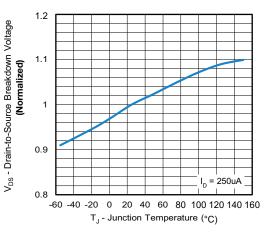


Fig. 11 - Temperature vs. Drain-to-Source Voltage



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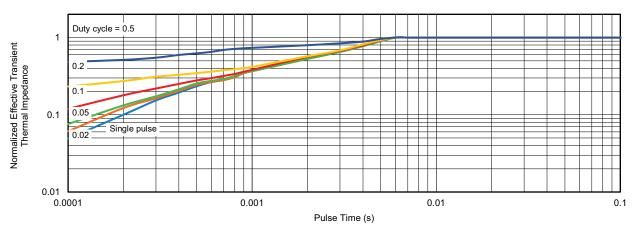


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

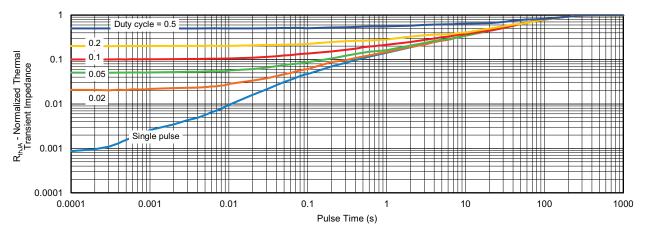


Fig. 13 - Normalized Transient Thermal Impedance, Junction-to-Ambient

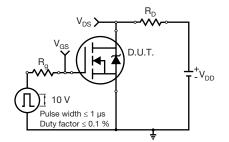


Fig. 14 - Switching Time Test Circuit

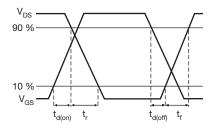


Fig. 15 - Switching Time Waveforms

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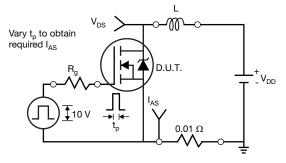


Fig. 16 - Unclamped Inductive Test Circuit

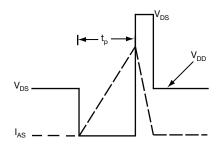


Fig. 17 - Unclamped Inductive Waveforms

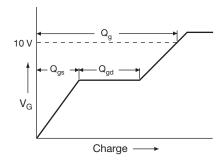


Fig. 18 - Basic Gate Charge Waveform

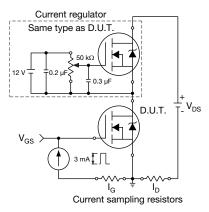


Fig. 19 - Gate Charge Test Circuit

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#### Peak Diode Recovery dv/dt Test Circuit

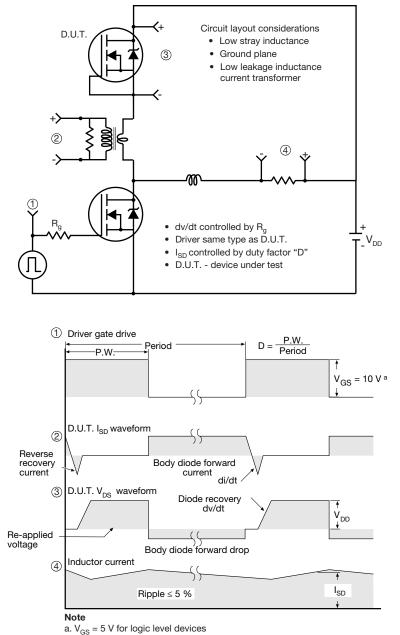


Fig. 20 - For N-Channel

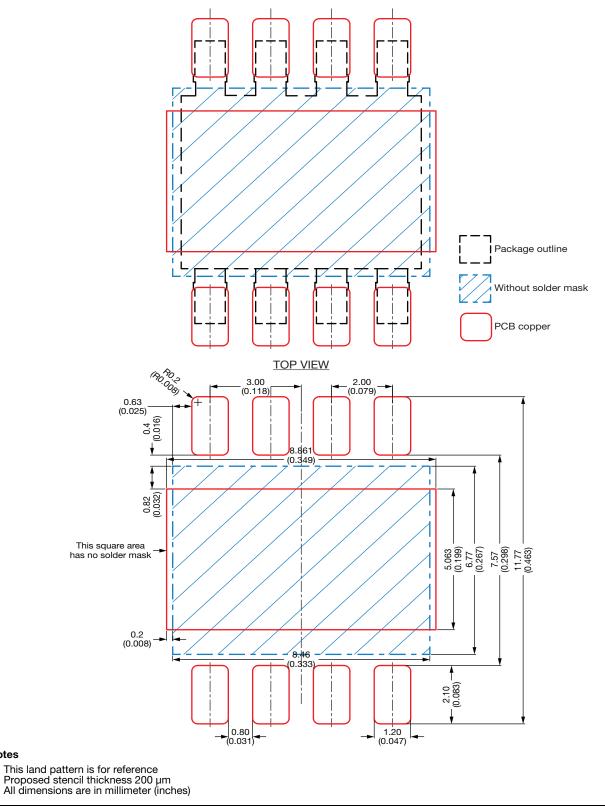
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### **PAD** Pattern



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# **Recommended Land Pattern PowerPAK® 8 x 8LR**



ECN: S23-1106-Rev. A, 11-Dec-2023 DWG: 3022

Revision: 11-Dec-2023

Notes

1

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